Declaration and Power of Attorney For Patent Application English Languag Declaration

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first

As a below named inventor. I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD OF MANUFACTURING CIRCUIT BOARD AND COMMUNICATION APPLIANCE, the specification of which is attached hereto unless the following box is checked: was filed on United States Application Number or PCT International Application Number and was amended on August 4, 2003 by Preliminary Amendment (if applicable). I hereby state that I have reviewed and understand the contents of the above identified specification. including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56. I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed: Prior Foreign Application(s) Priority Not Claimed 2002-228617 6 August 2002 (Day/Month/Year Filed) (Number) (Country)

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

(Day/Month/Year Filed)

(Application Number) (Filing Date)
(Application Number) (Filing Date)

(Country)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filling date of the prior application and the national or PCT international filling date of this application:

(Number)

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(Application Number)		(Filing Date)	(Status - pater	(Status - patented, pending, abandoned)		
(Application Number)		(Filing Date)	(Status - pater	(Status - patented, pending, abandoned)		
POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:						
Robert L. Andersen Daniel N. Calder Joshua L. Cohen Kevin W. Goldslein Costas S. Krlkells Bruce M. Monroe Kenneth N. Nigon Allan Ratner Jonathan H. Spadt	Reg. No. 25,771 Reg. No. 27,424 Reg. No. 38,040 Reg. No. 34,608 Reg. No. 28,028 Reg. No. 33,602 Reg. No. 31,549 Reg. No. 19,717 Reg. No. 45,122	Lawrence E. Ashery Loweil L. Carson Rex A. Donnelly, IV William P. Hauser Benjamin E. Leace Andrew L. Ney Parmela D. Politis Robert P. Sellter Christopher M. Spletzer	Reg. No. 34,515 Reg. No. 48,548 Reg. No. 41,712 Reg. No. 26,277 Reg. No. 33,412 Reg. No. 20,300 Reg. No. 47,865 Reg. No. 24,856 Reg. No. 52,240	Sleven E. Bach Kevin R. Casey Jacques L. Etkowlcz Jack J. Jankovitz Christopher R. Lewis Paul F. Prestia James C. Simmons Frank Tise Stanley Weinberg	Reg. No. 42,690	
Address all correspondence to:						
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Full name of sole or first inventor (given name, family name) Hideo KANZAWA						
Inventor's signature Date Date Date Cessidence Osaka, JAPAN Citizenship Japanese Post Office Address 2-1-9, Shodainakamachi, Hirakata-shi, Osaka 573-1152 JAPAN						
Full name of second joint inventor, if any (given name, family name) <u>Satoru YUUHAKU</u>						
Second Inventor's signature						
——————————————————————————————————————						
Additional inventors are being named on separately numbered sheets attached hereto.						

Yoshitake HAYASHI						
Full name of third joint inventor, if any (given name, family name) Yoshitake HAYASHI						
Third inventor's signature	Date					
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Full name of fourth joint inventor, if any (given name, family name)						
Fourth inventor's signature	_ Date					
Residence						
Citizenship						
Post Office Address						
Full name of fifth joint inventor, if any (given name, family name)						
Fifth inventor's signature	Date					
Residence						
Citizenship						
Post Office Address						
Full name of sixth joint Inventor, if any (given name, family name)						
Sixth inventor's signature	Date					
Residence						
Citizenship						
Post Office Address						
MATERIAL I						
Full name of seventh joint inventor, if any (given name, family name)						
Seventh inventor's signature	Date					
Residence						
Citizenship						
Post Office Address						
I .						